Vishay Siliconix

Automotive P-Channel 60 V (D-S) 175 °C MOSFET

Marking code: Q057

PRODUCT SUMMARY			
V _{DS} (V)	-60		
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.065		
$R_{DS(on)}$ (Ω) at $V_{GS} = -4.5 \text{ V}$	0.090		
I _D (A)	-16		
Configuration	Single		
Package	PowerPAK 1212-8W		

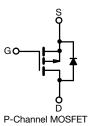
FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912





ROHS COMPLIANT HALOGEN FREE



PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	-60	V
Gate-source voltage		V_{GS}	± 20	
Continuous drain current	T _C = 25 °C a	- I _D	-16	-
	T _C = 125 °C		-11.5	
Continuous source current (diode conduction) ^a		I _S	-16	Α
Pulsed drain current ^b		I _{DM}	-64	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-23	
Single pulse avalanche energy	L = U.1 IIII	E _{AS}	26	mJ
Maximum power dissipation	T _C = 25 °C	P _D	53	w
	T _C = 125 °C		17	
Operating junction and storage temperature range Soldering recommendations (peak temperature) d, e		T _J , T _{stg}	-55 to +175	°C
			260	-0

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB Mount c	R_{thJA}	81	°C/W	
Junction-to-case (drain)	ction-to-case (drain)		2.8	C/VV	

Notes

- a. Package limited
- b. Pulse test; pulse width $\leq 300 \, \mu s$, duty cycle $\leq 2 \, \%$
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8W is a leadless package. The end of the lead terminals is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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V _{DS} V _{GS(th)} I _{GSS}	V _{DS} =	= 0 V, I _D = -250 μA V _{GS} , I _D = -250 μA	-60			
V _{GS(th)}	V _{DS} =	, 5	-60			
I _{GSS}		V _{GS} , I _D = -250 μA		-	-	V
I _{GSS}	V _{DS} =		-1.5	-2.0	-2.5	
I _{DSS}		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
I _{DSS}	$V_{GS} = 0 V$	V _{DS} = -60 V	-	-	-1	μΑ
	V _{GS} = 0 V	V _{DS} = -60 V, T _J = 125 °C	-	_	-50	
200	V _{GS} = 0 V	V _{DS} = -60 V, T _J = 175 °C	-	-	-150	
I _{D(on)}	V _{GS} = -10 V	V _{DS} ≤ -5 V	-15	-	-	Α
R _{DS(on)}	V _{GS} = -10 V	I _D = -5.7 A	-	0.049	0.065	Ω
	V _{GS} = -10 V	I _D = -5.7 A, T _J = 125 °C	_	_	0.110	
		$I_D = -5.7 \text{ A}, T_J = 175 \text{ °C}$	_	_	0.136	
	V _{GS} = -4.5 V	I _D = -4.4 A,	_	0.069	0.090	
9fs		: -15 V, I _D = -5.7 A	_	13	-	S
913	1 100	,.,				
C _{iss}			-	1083	1385	
Coss	V _{GS} = 0 V	V _{DS} = -25 V, f = 1 MHz	-	132	165	pF
C _{rss}			-	80	105	
			-	25.5	38	
	V _{GS} = -10 V	$V_{DS} = -30 \text{ V}, I_D = -5.7 \text{ A}$	-	4.3	-	nC
			_		-	
	1	f = 1 MHz	3.0	5.6	8.3	Ω
	V_{DD} = -30 V, R_L = 30 Ω I_D \cong -1 A, V_{GEN} = -10 V, R_g = 1 Ω		_			- ns
			_	_		
			_			
			_			
•						
	T		-	-	-64	Α
	I _F = -6 A, V _{GS} = 0 V		-	-0.85	-1.2	V
t _{rr}			-	26	52	ns
Q _{rr}			-	35	70	nC
	^	A di/dt = 100 A /v.c				
ta] I _F = -2	A, di/dt = 100A/μs	-	21	-	ns
	$\begin{array}{c} Q_g \\ Q_{gs} \\ Q_{gd} \\ R_g \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ t_{ISM} \\ V_{SD} \\ t_{rr} \end{array}$	$\begin{array}{c} Q_g \\ \hline Q_{gs} \\ \hline Q_{gd} \\ \hline \\ R_g \\ \hline t_{d(on)} \\ \hline t_r \\ \hline t_{d(off)} \\ \hline t_f \\ \hline \\ tics \ ^b \\ \hline I_{SM} \\ \hline V_{SD} \\ \hline t_{rr} \\ \hline Q_{rr} \\ \\ \end{array}$	$\begin{array}{c c} Q_g & \\ \hline Q_{gs} & \\ \hline Q_{gd} & \\ \hline \\ R_g & \\ \hline \\ t_{d(on)} & \\ \hline \\ t_r & \\ \hline \\ t_{d(off)} & \\ \hline \\ t_f & \\ \hline \\ t_{ics} ^b & \\ \hline \\ I_{SM} & \\ \hline \\ V_{SD} & \\ \hline \\ I_{F} = -6 A, V_{GS} = 0 V \\ \hline \\ t_{rr} & \\ \hline \\ Q_{rr} & \\ \hline \end{array}$	$\begin{array}{c c} Q_g & & & & & & & & & & & & & & & & & & &$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

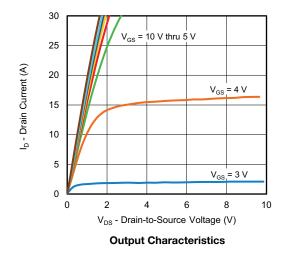
Notes

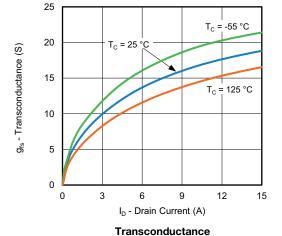
- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

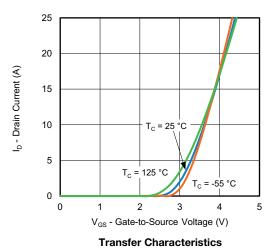
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

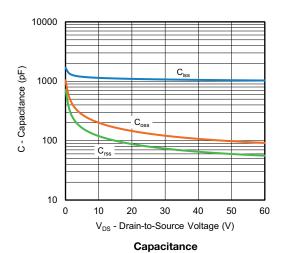


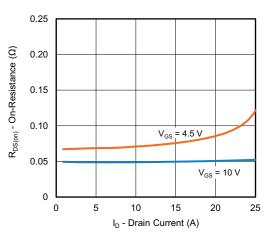
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

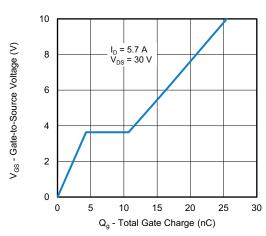








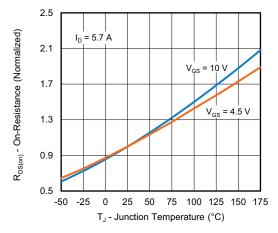




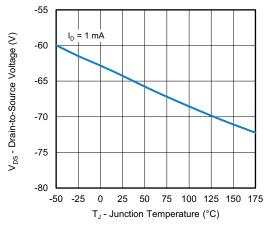
On-Resistance vs. Drain Current



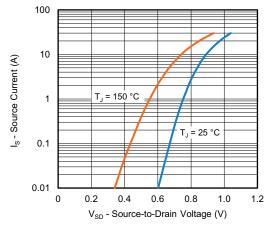
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



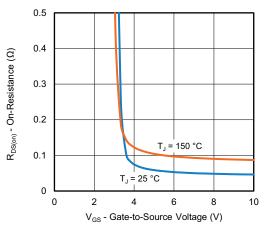
On-Resistance vs. Junction Temperature



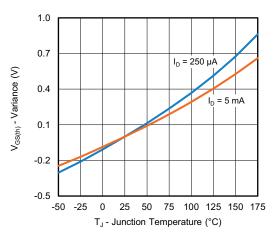
Drain Source Breakdown vs. Junction Temperature



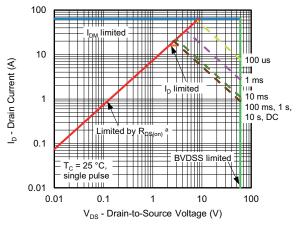
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Safe Operating Area

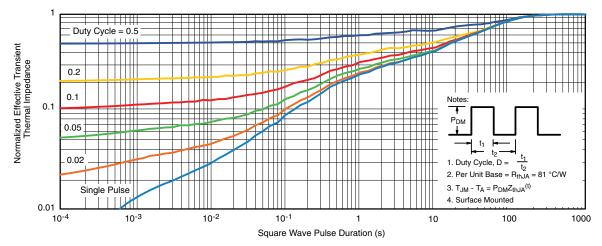
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

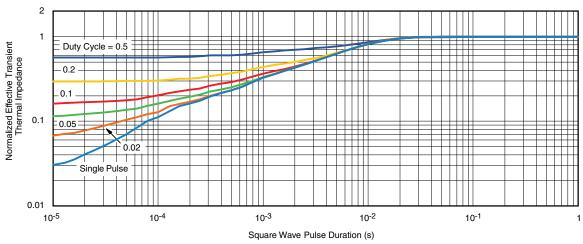
For technical questions, contact: automostech



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63050.



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